imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



New Product



Si4154DY Vishay Siliconix

RoHS

COMPLIANT

HALOGEN

FREE

N-Channel 40-V (D-S) MOSFET

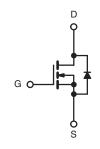
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
40	0.0033 at V _{GS} = 10 V	36	32.5 nC		
	0.0039 at V _{GS} = 4.5 V	33	32.5 110		

FEATURES

- Halogen-free According to IEC 61249-2-21 ٠ Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested ٠
- Compliant to RoHS Directive 2002/95/EC ٠

APPLICATIONS

- POL
- Synchronous Rectification



S D 8 1 D S 7 2 S D 6 3 D G 5 4 Top View

Ordering Information: SI4154DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	40	v	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		36		
Continuous Drain Current ($T_{1} = 150 \ ^{\circ}C$)	T _C = 70 °C	1 [26		
Continuous Drain Guirent (1) = 130 O)	T _A = 25 °C	Ι _D	24 ^{b, c}		
	T _A = 70 °C	1 [19 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	70	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1.	7.0		
Continuous Source-Drain Diode Current	T _A = 25 °C	- I _S	3.1 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	40		
Avalanche Energy L = 0.1 mH		E _{AS}	80	mJ	
Maximum Power Dissipation	T _C = 25 °C		7.8		
	T _C = 70 °C	P _D	5.0	w	
	T _A = 25 °C	'D	3.5 ^{b, c}	V V	
	T _A = 70 °C	1 1	2.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Typical	Maximum
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	29	35
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	13	16

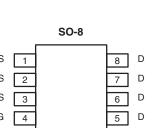
Notes:

a. Based on $T_C = 25$ °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 80 °C/W.



Unit °C/W

Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•	·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050		45		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	– Ι _D = 250 μΑ		- 5.6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.0		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			А	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A		0.0027	0.0033	<u> </u>	
		V _{GS} = 4.5 V, I _D = 10 A		0.0032	0.0039	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		75		S	
Dynamic ^b	I						
Input Capacitance	C _{iss}			4230			
Output Capacitance	C _{oss}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz		570		pF	
Reverse Transfer Capacitance	C _{rss}			220			
Total Gate Charge		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		70	105	nC	
	Q _g			32.5	49		
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		9.7			
Gate-Drain Charge	Q _{gd}	7		8.6			
Gate Resistance	Rg	f = 1 MHz	0.3	1.25	2.5	Ω	
Turn-On Delay Time	t _{d(on)}			25	50	ns	
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		70	120		
Turn-Off Delay Time	t _{d(off)}	$\rm I_D \cong 10$ A, $\rm V_{GEN}$ = 4.5 V, $\rm R_g$ = 1 Ω		51	90		
Fall Time	t _f			35	60		
Turn-On Delay Time	t _{d(on)}			10	20		
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		9	18		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 10 A, V_GEN = 10 V, R_g = 1 Ω		35	60		
Fall Time	t _f	7		7	14		
Drain-Source Body Diode Characteristi	cs	·					
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			7.0		
Pulse Diode Forward Current ^a	I _{SM}			1	70	A	
Body Diode Voltage	V _{SD}	I _S = 3 A		0.71	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			33	65	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			29	56	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		17		ns	
Reverse Recovery Rise Time	t _b	1		16			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

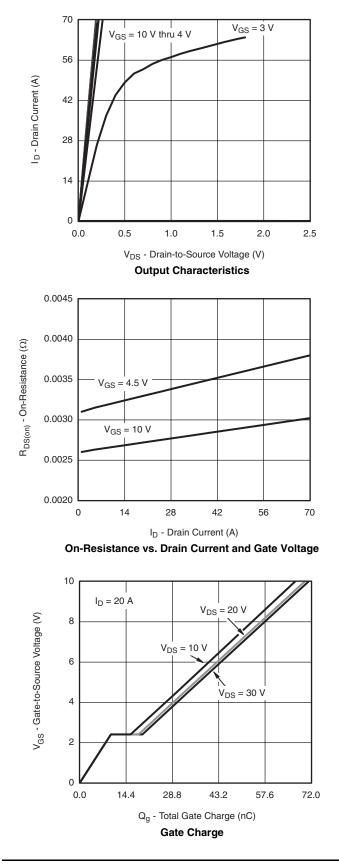
b. Guaranteed by design, not subject to production testing.

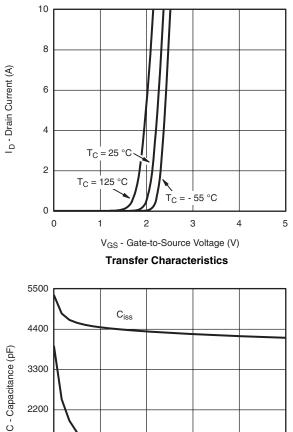
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

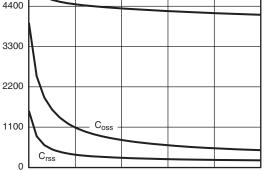


Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Capacitance

V_{DS} - Drain-to-Source Voltage (V)

18

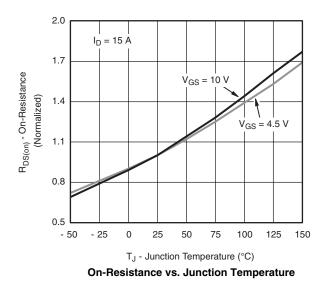
24

30

12

6

0



Document Number: 65000 S09-0998-Rev. A, 01-Jun-09

Vishay Siliconix



 $I_D = 15 A$

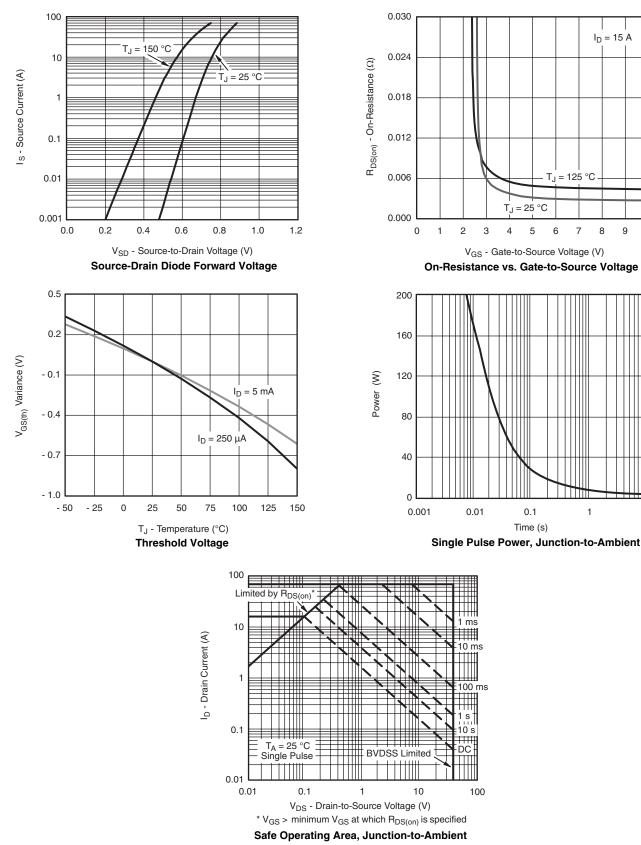
T_J = 125 °C

1

10

6 7 8 9 10

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



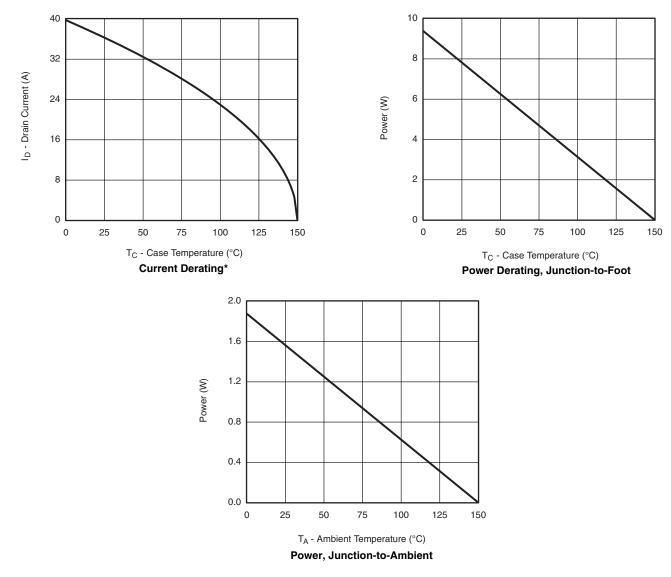
New Product



Si4154DY

Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

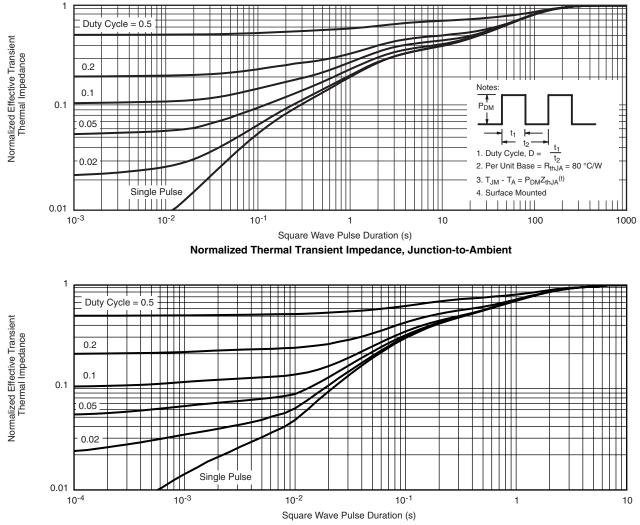


* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65000.



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.